

V_{DRM}	=	4500 V
I_{TGQM}	=	3800 A
I_{TSM}	=	28×10^3 A
$V_{(T0)}$	=	1.7 V

Asymmetric Integrated Gate- Commutated Thyristor 5SHY 35L4511

- AC or DC supply voltage
- Contact factory for series connection

Blocking

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Rep. peak off-state voltage	V_{DRM}	Gate Unit energized			4500	V
Permanent DC voltage for 100 FIT failure rate of GCT	$V_{DC-link}$	Ambient cosmic radiation at sea level in open air. Gate Unit energized			2800	V
Reverse voltage	V_{RRM}	IGCT in off-state			17	V
		IGCT in on-state			10	V

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Rep. peak off-state current	I_{DRM}	$V_D = V_{DRM}$, Gate Unit energized			50	mA

Mechanical data (see Fig. 11, 12)

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_m		36	40	44	kN

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Pole-piece diameter	D_p	± 0.1 mm		85		mm
Housing thickness	H		25.3		25.8	mm
Weight	m				2.9	kg
Surface creepage distance	D_s	Anode to Gate	33			mm
Air strike distance	D_a	Anode to Gate	10			mm
Length	l	± 1.0 mm		439		mm
Height	h	± 1.0 mm		40		mm

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GCT Data

On-state (see Fig. 3, 4, 5, 6, 14, 15)

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	$I_{T(AV)M}$	Half sine wave, $T_C = 85\text{ °C}$, Double side cooled			1420	A
Max. RMS on-state current	$I_{T(RMS)}$				2240	A
Max. peak non-repetitive surge on-state current	I_{TSM}	$t_p = 10\text{ ms}$, $T_j = 125\text{ °C}$, sine wave after surge: $V_D = V_R = 0\text{ V}$			28×10^3	A
Limiting load integral	I^2t				3.92×10^6	A^2s
Max. peak non-repetitive surge on-state current	I_{TSM}	$t_p = 30\text{ ms}$, $T_j = 125\text{ °C}$, sine wave after surge: $V_D = V_R = 0\text{ V}$			19×10^3	A
Limiting load integral	I^2t				5.415×10^6	A^2s
Stray inductance between GCT and antiparallel diode	L_D	Only relevant for application antiparallel diode to the IGC			300	nH
Critical rate of rise of on-state current	di_T/dt_{cr}	For higher di_T/dt and current than 100 A an external retri is required.				A/ μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 3300\text{ A}$, $T_j = 125\text{ °C}$		2.95	3.1	V
Threshold voltage	$V_{(T0)}$	$T_j = 125\text{ °C}$				
Slope resistance	r_T	$I_T = 1000 \dots 3300\text{ A}$				

Turn-on switching (see Fig. 14, 15)

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di_T/dt_{cr}	$f = 0.500\text{ Hz}$, $T_j = 125\text{ °C}$, $V_D = 2800\text{ V}$, $I_{TM} \leq 3300\text{ A}$				

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Turn-on delay time	t_{don}	$V_D = 2800\text{ V}$, T_j			3.5	μs
Turn-on delay time status feedback	$t_{don SF}$				7	μs
Rise time	t_r				1	μs

Turn-on energy per pulse E_{on}

Gate Unit Data

Power supply (see Fig. 2, 9, 10, 12, 13)

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate Unit voltage (Connector X1)	$V_{GIN,RMS}$	AC square wave amplitude (15 kHz - 100kHz) or DC voltage. No galvanic isolation to power circuit.	28		40	V
Min. current needed to power up the Gate Unit	$I_{GIN Min}$	Rectified average current see application note 5SYA 2031	2.1			A
Gate Unit power consumption	$P_{GIN Max}$				100	W

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Internal current limitation	$I_{GIN Max}$	Rectified average current limited by the Gate Unit			8	A

Optical control input/output ²⁾

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Min. on-time	t_{on}		40			μ s
Min. off-time	t_{off}		40			μ s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Optical input power	$P_{on CS}$	CS: Control signal SF: Status feedback Valid for 1mm plastic optical fiber (POF)	-15		-1	dBm
Optical noise power	$P_{off CS}$				-45	dBm
Optical output power	$P_{on SF}$		-19		-1	dBm
Optical noise power	$P_{off SF}$				-50	dBm
Pulse width threshold	t_{GLITCH}	Max. pulse width without response			400	ns
External retrigger pulse width	t_{retrig}		600		1100	ns

2) Do not disconnect or connect fiber optic cables while light is on.

Connectors ²⁾ (see Fig. 11, 12, 13)

Parameter	Symbol	Description
Gate Unit power connector	X1	AMP: MTA-156, Part Number 641210-5 ³⁾
LWL receiver for command signal	CS	Agilent, Type HFBR-2528 ⁴⁾
LWL transmitter for status feedback	SF	Agilent, Type HFBR-1528 ⁴⁾

2) Do not disconnect or connect fiber optic cables while light is on.

3) AMP, www.amp.com

4) Agilent Technologies, www.semiconductor.agilent.com

Visual feedback (see Fig. 13)

Parameter	Symbol	Description	Color
Gate OFF	LED1	"Light" when GCT is off	(green)
Gate ON	LED2	"Light" when gate-current is flowing	(yellow)
Fault	LED3	"Light" when not ready / Failure	(red)
Power supply voltage OK	LED4	"Light" when power supply is within specified range	(green)

Thermal*Maximum rated values ¹⁾*

Parameter	Symbol	Conditions	min	typ	max	Unit
Junction operating temperature	T_{vj}		10		125	°C
Storage temperature range	T_{stg}		-40		60	°C
Ambient operational temperature	T_a		10		50	°C

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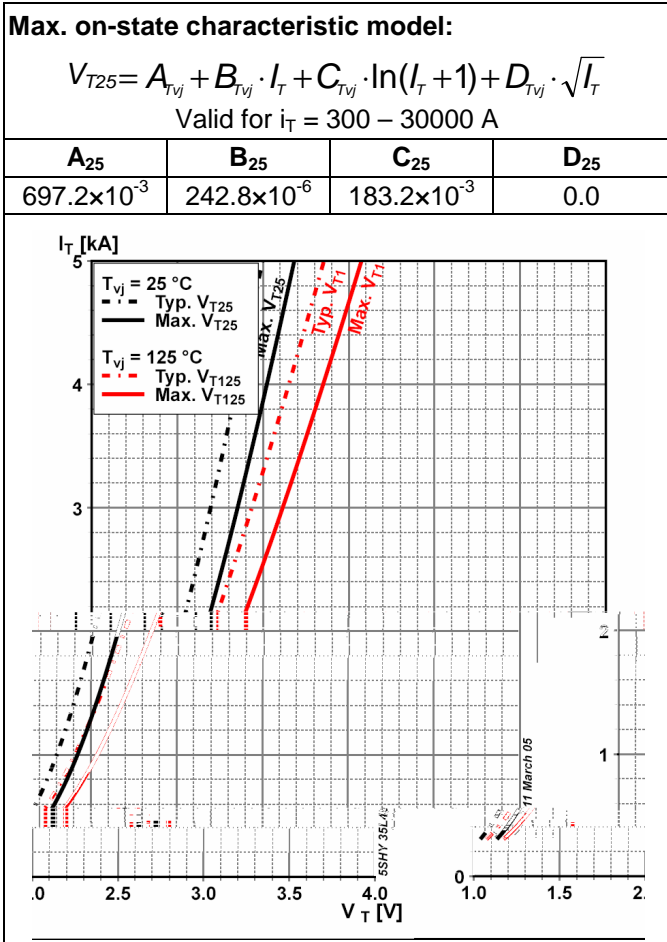


Fig. 3 GCT on-state voltage characteristics

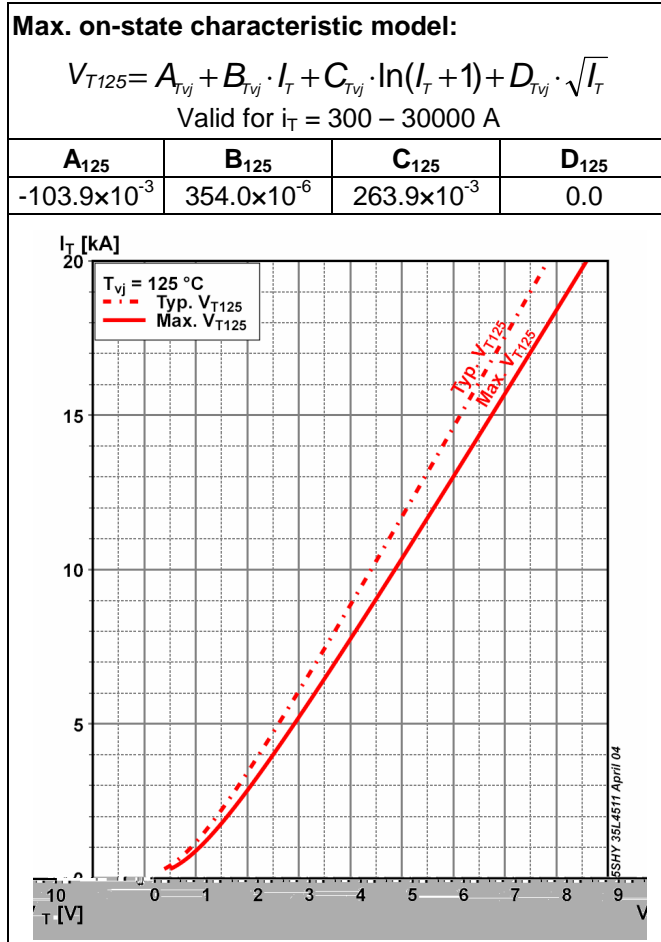


Fig. 4 GCT on-state voltage characteristics

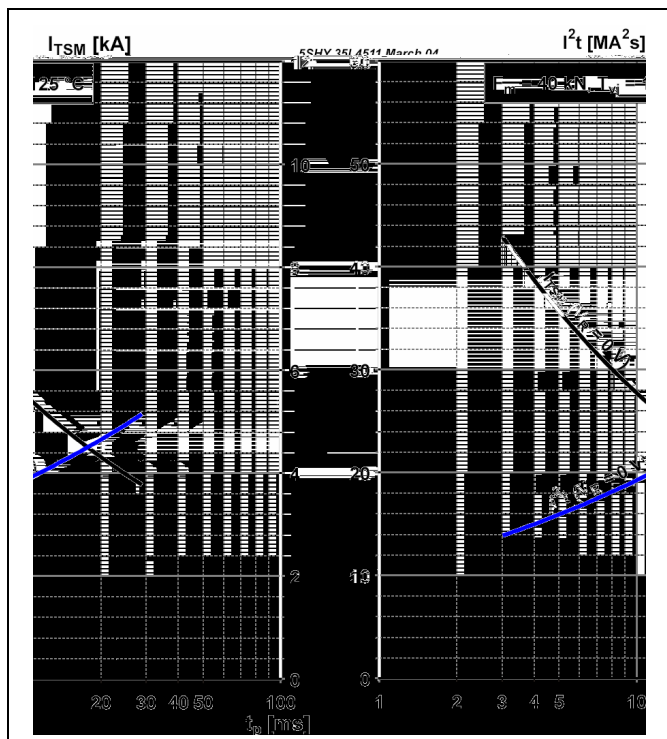


Fig. 5 Surge on-state current vs. pulse length, half-sine wave

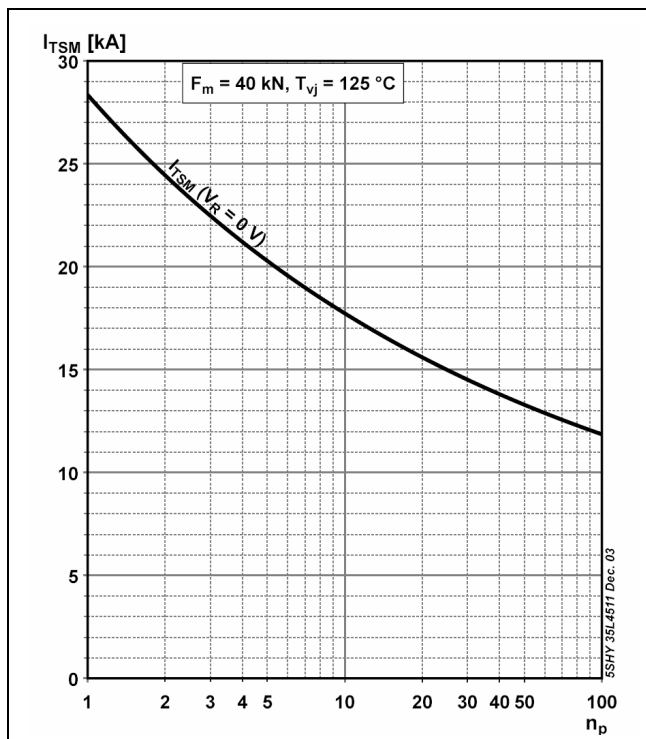


Fig. 6 Surge on-state current vs. number of pulses, half-sine wave, 10 ms, 50Hz



Related documents:

5SYA 2031	Applying IGCT Gate Units
5SYA 2032	Applying IGCTs
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
5SYA 2046	Failure rates of IGCTs due to cosmic rays
5SYA 2048	Field measurements on High Power Press Pack Semiconductors
5SYA 2051	Voltage ratings of high power semiconductors
5SZK 9107	Specification of environmental class for pressure contact IGCTs, OPERATION available on request, please contact factory

Please refer to <http://www.abb.com/semiconductors> for current version of documents.

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